

PNP Power Silicon Transistor Chips

Rev. V1

Features

- JANS and JANSR Qualified to MIL-PRF-19500/545
- Lightweight & Low Power
- Ideal for Space, Military, and Other High Reliability Applications

Electrical Characteristics (T_c = +25°C unless otherwise specified)

Parameter	Test Conditions		I Units Min.		Max.	
Collector - Emitter Breakdown Voltage	I _C = -100 mA dc; I _B = 0	V _{(BR)CEO}	V dc	-80	_	
Emitter - Base Cutoff Current	$V_{EB} = -4.0 \text{ V dc}; I_{C} = 0$ $V_{EB} = -5.5 \text{ V dc}; I_{C} = 0$	I _{EBO1}	µA dc mA dc		-1.0 -1.0	
Collector - Emitter Cutoff Current	V _{CE} = -60 V dc; V _{BE} = 0 V _{CE} = -100 V dc; V _{BE} = 0	I _{CES1} I _{CES2}	µA dc mA dc	_	-1.0 -1.0	
Collector - Emitter Cutoff Current	V_{CE} = -40 V dc; I _B = 0	I _{CEO}	µA dc	_	-50	
	r 	L				
Forward Current Transfer Ratio	V _{CE} = -5.0 Vdc; I _C = -50 mA dc 2N5151 2N5153 V _{CE} = -5.0 Vdc; I _C = -2.5 A dc			20 50		
	2N5151 2N5153 $V_{CE} = -5.0$ Vdc; I _C = -5.0 A dc	h _{FE}	-	30 70	90 200	
	2N5151 2N5153			20 40	_	
Collector - Emitter Saturation Voltage	I_{C} = -2.5 A dc; I_{B} = -250 mA dc I_{C} = -5.0 A dc; I_{B} = -500 mA dc	$\begin{array}{c} V_{CE(sat)1} \\ V_{CE(sat)2} \end{array}$	V dc	—	-0.75 -1.50	
Base - Emitter Voltage (Non-Saturated)	V_{CE} = -5.0 V dc; I _C = -2.5 A dc	$V_{\text{B}E(on)}$	V dc	—	-1.45	
Base - Emitter Saturation Voltage	I_{C} = -2.5 A dc; I_{B} = -250 mA dc I_{C} = -5.0 A dc; I_{B} = -500 mA dc	$\begin{array}{c} V_{BE(sat)1} \\ V_{BE(sat)2} \end{array}$	V dc	—	-1.45 -2.20	
Magnitude of Common Emitter Small-Signal Short-Circuit, Forward Current, Transfer Ratio	V _{CE} = -5.0 Vdc; I _C = -500 mA dc; f = 10 MHz 2N5151 2N5153	h _{fe}	-	6 7	_	
Common-Emitter, Small-Signal Short-Circuit Forward Current Transfer Ratio	V _{CE} = -5.0 V dc; I _C = -100 mA dc; f = 1 kHz 2N5151 2N5153	h _{fe}	-	20 50	_	
Open-Circuit Output Capacitance	V_{CB} = -10 V dc, I _E = 0, f = 1 MHz	C _{obo}	pF	_	250	

¹

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Electrical Characteristics (T_c = +25°C unless otherwise specified)

Parameter	Test Conditions		Units	Min.	Max.
Collector - Emitter Cutoff Current	T _C = +150°C V _{CE} = -60 V dc; V _{BE} = + 2 V dc	I _{CEX}	µA dc	_	-25
Forward - Current Transfer Ratio	T _C = -55°C V _{CE} = -5 V dc; I _C = -2.5 A dc 2N5151 2N5153	h _{FE4}	-	15 25	

Absolute Maximum Ratings (T_c = +25°C unless otherwise specified)

Ratings	Symbol	Value
Collector - Emitter Voltage	V_{CEO}	-80 V dc
Collector - Base Voltage	V _{CBO}	-100 V dc
Emitter - Base Voltage	V _{EBO}	-5.5 Vdc
Collector Current	Ι _C	-2 A dc -10 A dc ⁽³⁾
Reverse Pulse Energy ⁽⁴⁾		15 mj
Operating & Storage Temperature Range	T_J, T_{STG}	-65°C to +200°C

(3) The value applies for $pw \le 8.3 \text{ ms}$, duty cycle ≤ 1 percent.

(4) This rating is based on the capability of the transistors to operate safely in the unclamped inductive load energy test circuit, see subgroup 5 of the group A inspection table and figure 13 of MIL-PRF-19500/545.



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Electrical Characteristics (T_c = +25°C unless otherwise specified)

Parameter	Parameter Test Conditions		Units	Min.	Max.		
Switching Characteristics							
Turn-On Time	I_{C} = -5 A dc; I_{B1} = -500 mA dc, R_{L} = 6 Ω, I_{B2} = -500 mA dc, $V_{BE(off)}$ = -3.7 Vdc	t _{on}	μs	—	0.5		
Turn-Off Time		t _{off}	μs	_	1.5		
Storage Time		ts	μs	_	1.4		
Fall Time		t _f	μs	—	0.5		

Safe Operating Area

DC Tests:	$T_{\rm C}$ = +25°C, I Cycle, $t_{\rm p}$ = 1 s	
Test 1: Test 2: Test 3:	V_{CE} = -5.8 V dc; I _C = -2 A dc V_{CE} = -32 Vdc; I _C = -360 mA dc V_{CE} = -80 Vdc; I _C = -14.5 mA dc	

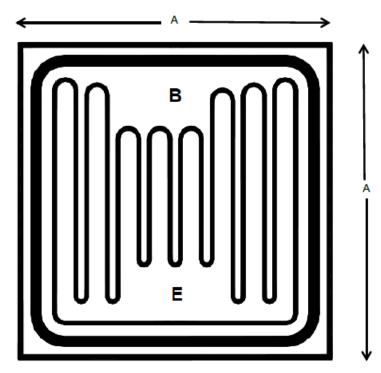
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Outline Drawing (Chip)



Backside: Collector

Dimensions					
LTR	Inches		Millimeters		
	Min	Мах	Min	Max	
А	.118	.122	3.0	3.1	

NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for general information only.
- 3. Unless otherwise specified, tolerance is ±.005 (0.13 mm).
- The physical characteristics of the die are:
 - Thickness:
Top metal:.0135 inch (0.34 mm) nominal, tolerance is \pm .0015 inch (0.04 mm).Back metal:
Back side:Aluminum, 54,000 Å minimum, 60,000 Å nominal.Back side:
Bonding pad:Gold 6,400 Å minimum, 8,000 Å nominal.Collector.
B = .038 x .022 inch (0.97 x 0.56 mm)
E = .042 x .020 inch (1.07 mm x 0.51 mm)

FIGURE 5. JANHC and JANKC (D-version) die dimensions.

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